10/582995

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IAP20 Rec'd PCT/PTO 14 JUN 2006

PATENT COOPERATION TREATY

Applicants

Shigeki Satou et al.

Int'l Application No.:

PCT/JP2004/018627

Int'l Filing Date

December 14, 2004

Title

DIELECTRIC PASTE FOR SPACER LAYER OF A

MULTI-LAYERED CERAMIC ELECTRONIC

COMPONENT

Docket No.

: 890050.541USPC

Date

: June 14, 2006

Mail Stop PCT P.O. Box 1450 Alexandria, VA 22313-1450

INFORMATION DISCLOSURE STATEMENT TRANSMITTAL

Commissioner for Patents:

In accordance with 37 CFR 1.56 and 1.97 through 1.98, applicants wish to make known to the U.S. Patent and Trademark Office the references set forth on the attached Information Disclosure Statement. Copies of cited U.S. patents and published patent applications are not required and accordingly have not been provided. Copies of any other cited references are enclosed. As to any reference cited, applicants do not admit that it is "prior art" under 35 U.S.C. §§ 102 or 103, and specifically reserve the right to traverse or antedate any such reference, as by a showing under 37 CFR 1.131 or other method. Although the aforesaid references are made known to the Patent and Trademark Office in compliance with applicants' duty to disclose all information they are aware of which is believed relevant to the examination of the above-identified application, applicants believe that their invention is patentable.

Please acknowledge receipt of this Information Disclosure Statement and kindly make the cited references of record in the above-identified application.

10/582995 iAP20 Rec'd PCT/PTO 14 JUN 2006

Applicants attorney states that a co-pending case filed today bearing the title "DIELECTRIC PASTE FOR SPACER LAYER OF A MULTI-LAYERED CERAMIC ELECTRONIC COMPONENT", PCT application number PCT/JP2004/018628 and an International Filing Date of December 14, 2004. These two applications are in the same general technology areas and we wish to provide this information to the Examiner.

Applicants believe this Information Disclosure Statement has been timely filed, however, the Director is authorized to charge any fee due by way of this Information Disclosure Statement to our Deposit Account No. 19-1090.

Respectfully submitted,

Seed Intellectual Property Law Group PLLC

David V. Carlson

Registration No. 31,153

DVC:lcs

Enclosures:

Information Disclosure Statement Cited References (6)

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EXPRESS MAIL NO. EV529787137US Sheet 1 of 1

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